

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Da-Wei LAI</td> <td>06/11/2012</td> </tr> <tr> <td>Handoko LINEWIH</td> <td>06/11/2012</td> </tr> </tbody> </table>		Name	Execution Date	Da-Wei LAI	06/11/2012	Handoko LINEWIH	06/11/2012				
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>GLOBALFOUNDRIES Singapore Pte. Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>60 Woodlands Industrial Park D Street 2</td> </tr> <tr> <td>City:</td> <td>Singapore</td> </tr> <tr> <td>State/Country:</td> <td>SINGAPORE</td> </tr> <tr> <td>Postal Code:</td> <td>738406</td> </tr> </table>		Name:	GLOBALFOUNDRIES Singapore Pte. Ltd.	Street Address:	60 Woodlands Industrial Park D Street 2	City:	Singapore	State/Country:	SINGAPORE	Postal Code:	738406
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
<p>Fax Number: (656)846-2005</p> <p>Phone: +65 9836 9908</p> <p>Email: oa.notification@horizonip.com.sg</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Horizon IP Pte Ltd.</p> <p>Address Line 1: 7500A Beach Road, #04-306/308</p> <p>Address Line 2: The Plaza</p> <p>Address Line 4: Singapore, SINGAPORE 199591</p>											
ATTORNEY DOCKET NUMBER:	GFSP2011NAT50US0										
NAME OF SUBMITTER:	Dexter CHIN										
<p>Total Attachments: 4</p> <p>source=GFSP2011NAT50US0-Assignment#page1.tif</p> <p>source=GFSP2011NAT50US0-Assignment#page2.tif</p> <p>source=GFSP2011NAT50US0-Assignment#page3.tif</p> <p>source=GFSP2011NAT50US0-Assignment#page4.tif</p>											

CH \$40.00 13533959

ASSIGNMENT

For good and valuable consideration, we, Da-Wei LAI, residing at 3 Rosewood Drive #14-06, Woodlands, Singapore 737935, a citizen of Taiwan R.O.C.; Handoko LINEWIH, residing at 3 Rosewood Drive #14-06, Woodlands, Singapore 737935, a citizen of Australia;

Hereby sell, assign, and transfer to **GLOBALFOUNDRIES Singapore Pte. Ltd.**, a corporation of **Singapore**, having its principal place of business at **60 Woodlands Industrial Park D Street 2, Singapore 738406**,

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently here within, and is entitled:

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and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for

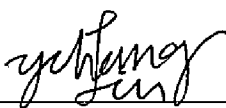
aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

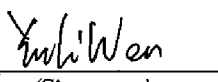
Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: June 11 2012



(Signature)

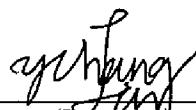
Da-Wei LAI

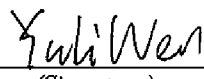
Witness 1: 
(Signature)
Yeh-Lung Lin
(Print name)

Witness 2: 
(Signature)
Yuh-Li Wen
(Print name)

Date: 11 June 2012


(Signature)
Handoko LINEWIIH

Witness 1: 
(Signature)
Lin, Ying-Chang
(Print name)

Witness 2: 
(Signature)
Yu Li Wen
(Print name)